Product data sheet

1. General description

Planar passivated four quadrant triac in a SOT78 (TO-220AB) plastic package intended for use in general purpose bidirectional switching and phase control applications.

2. Features and benefits

- · High voltage capability
- Least sensitive gate for highest noise immunity
- Planar passivated for voltage ruggedness and reliability
- Triggering in all four quadrants
- High minimum I_{GT} for guaranteed immunity to gate noise

3. Applications

- · General purpose motor controls
- General purpose switching

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | meter Conditions | | | | | Unit | | |
|-------------------------|------------------------------------------|-------------------------------------------------------------------------------------------|----|-----|-----|------|------|--|--|
| Absolute maximum rating | | | | | | | | | |
| V_{DRM} | repetitive peak off-state voltage | | 6 | 000 | | V | | | |
| I _{T(RMS)} | RMS on-state current | full sine wave; $T_{mb} \le 125 ^{\circ}\text{C}$; Fig. 1; Fig. 2; Fig. 3 | | , | 12 | | А | | |
| I _{TSM} | non-repetitive peak on- state current | full sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 20 \text{ ms}$; Fig. 4; Fig. 5 | 95 | | | | А | | |
| | | full sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 16.7 \text{ ms}$ | | | | | А | | |
| T _j | junction temperature | | | 1 | 50 | | °C | | |
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit | | |
| Static ch | aracteristics | | | | | | | | |
| I _{GT} | gate trigger current | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2+ G+;$ $T_j = 25 \text{ °C}; Fig. 7$ | | 10 | - | 50 | mA | | |
| | | $V_D = 12 \text{ V; } I_T = 0.1 \text{ A; } T2 + G-;$ $T_j = 25 \text{ °C; } Fig. 7$ | | 10 | - | 50 | mA | | |
| | | $V_D = 12 \text{ V; } I_T = 0.1 \text{ A; T2- G-;}$ $T_j = 25 \text{ °C; Fig. 7}$ | | 10 | - | 50 | mA | | |
| | | $V_D = 12 \text{ V; } I_T = 0.1 \text{ A; T2- G+;}$ $T_j = 25 \text{ °C; } Fig. 7$ | | 10 | - | 100 | mA | | |
| I _H | holding current | V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u> | | - | - | 60 | mA | | |
| V _T | on-state voltage | I _T = 15 A; T _j = 25 °C; <u>Fig. 10</u> | | - | 1.4 | 1.65 | V | | |

4Q Triad

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| Dynamic | characteristics | | | | | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 402 V; T_j = 150 °C; $(V_{DM}$ = 67% of V_{DRM}); exponential waveform; gate open circuit | 200 | - | - | V/µs |
| dI _{com} /dt | rate of change of commutating current | $V_D = 400 \text{ V}; T_j = 150 ^{\circ}\text{C}; I_{T(RMS)} = 12 \text{ A};$ $dV_{com}/dt = 20 \text{ V/}\mu\text{s}; \text{ (snubberless condition)}; \text{ gate open circuit}$ | 2 | 5 | - | A/ms |

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|--------------------------------|--------------------|----------------|
| 1 | T1 | main terminal 1 | mb | |
| 2 | T2 | main terminal 2 | 1 7 9 | T2_\T1 |
| 3 | G | gate | | sym051 |
| mb | T2 | mounting base; main terminal 2 | | Syllio31 |
| | | | | |
| | | | | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | ackage | | | | |
|--------------|----------|-------------------------------------------------------------------------------------|---------|--|--|--|
| | Name | Description | Version | | | |
| BT138-600G0T | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78 | | | |

7. Marking

Table 4. Marking codes

| Type number | Marking codes |
|--------------|---------------|
| BT138-600G0T | BT138-600G0T |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Values | Unit |
|---------------------|------------------------------------------|-----------------------------------------------------------------------|------------|------------------|
| V_{DRM} | repetitive peak off-state voltage | | 600 | V |
| I _{T(RMS)} | RMS on-state current | full sine wave; T _{mb} ≤ 125 °C; Fig 1; Fig 2; Fig 3 | 12 | А |
| I _{TSM} | non-repetitive peak on- state current | full sine wave; $T_{j(init)}$ = 25 °C; t_p = 20 ms; Fig 4; Fig 5 | 95 | А |
| | | full sine wave; $T_{j(init)}$ = 25 °C; t_p = 16.7 ms | 105 | А |
| l ² t | I ² t for fusing | t _p = 10 ms; sine-wave pulse | 45 | A ² s |
| dl _⊤ /dt | rate of rise of on-state | I _G = 0.2 A | 50 | A/µs |
| | current | I _G = 0.2 A | 50 | A/µs |
| | | I _G = 0.2 A | 50 | A/µs |
| | | I _G = 0.2 A | 10 | A/µs |
| I _{GM} | peak gate current | | 2 | Α |
| P_{GM} | peak gate power | | 5 | W |
| $P_{G(AV)}$ | average gate power | over any 20 ms period | 0.5 | W |
| T _{stg} | storage temperature | | -40 to 150 | °C |
| T _j | junction temperature | | 150 | °C |

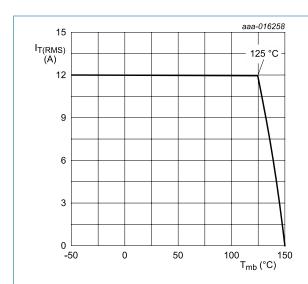
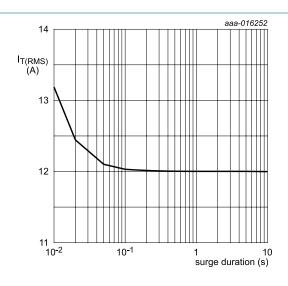
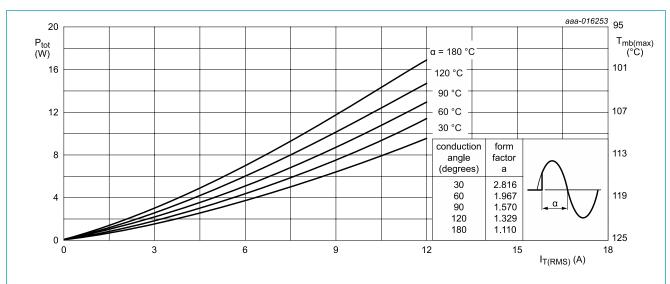


Fig. 1. RMS on-state current as a function of mounting base temperature; maximum values



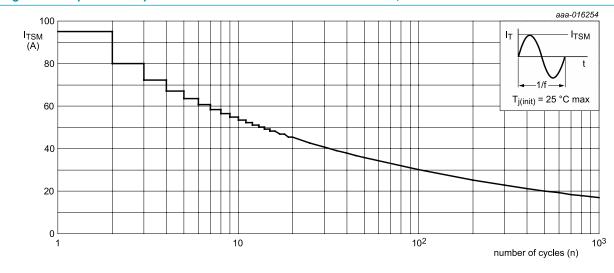
 $f = 50 \ Hz; \ T_{mb} = 125 \ ^{\circ}C$ Fig. 2. RMS on-state current as a function of surge duration; maximum values



 α = conduction angle

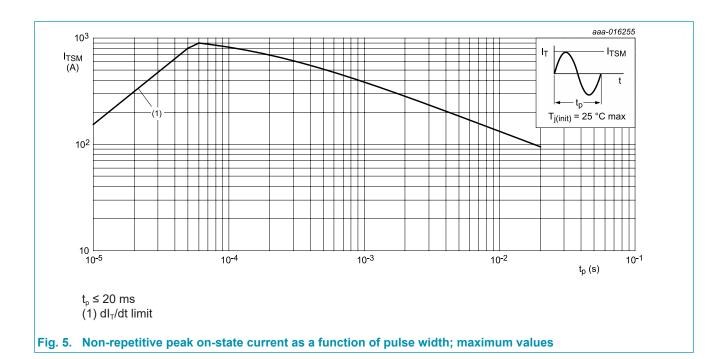
 $a = form factor = I_{T(RMS)} / I_{T(AV)}$

Fig. 3. Total power dissipation as a function of RMS on-state current; maximum values



f = 50 Hz

Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values



9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|---------------------------------------------------|-------------------|-----|-----|-----|------|
| R _{th(j-mb)} | thermal resistance | full cycle; Fig 6 | - | - | 1.5 | K/W |
| | from junction to mounting base | half cycle | - | - | 2 | K/W |
| R _{th(j-a)} | thermal resistance from junction to ambient | in free air | - | 60 | - | K/W |

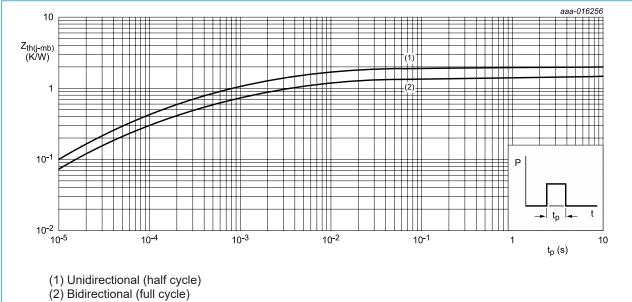
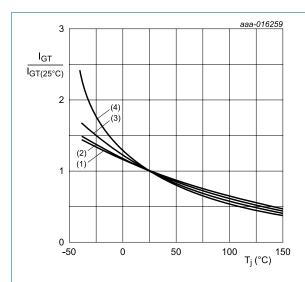


Fig. 6. Transient thermal impedance from junction to mounting base as a function of pulse duration

10. Characteristics

Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------------|---------------------------------------|-------------------------------------------------------------------------------------------------------------------------|------|-----|------|------|
| Static ch | aracteristics | | | | | |
| l _{GT} | gate trigger current | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2+ G+;$ $T_j = 25 \text{ °C}; Fig. 7$ | 10 | - | 50 | mA |
| | | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2+ G-;$ $T_j = 25 \text{ °C}; Fig. 7$ | 10 | - | 50 | mA |
| | | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2- \text{G-};$ $T_j = 25 \text{ °C}; \underline{\text{Fig. 7}}$ | 10 | - | 50 | mA |
| | | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T2- G+;$ $T_j = 25 \text{ °C}; Fig. 7$ | 10 | - | 100 | mA |
| IL | latching current | $V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T2+ G+;$ $T_j = 25 \text{ °C}; Fig. 8$ | - | - | 60 | mA |
| | | $V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T2+ G-;$ $T_j = 25 \text{ °C}; Fig. 8$ | - | - | 90 | mA |
| | | $V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T2- G-;$ $T_j = 25 \text{ °C}; Fig. 8$ | - | - | 60 | mA |
| | | $V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T2- G+;$ $T_j = 25 \text{ °C}; Fig. 8$ | - | - | 90 | mA |
| I _H | holding current | V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u> | - | - | 60 | mA |
| V _T | on-state voltage | I _T = 15 A; T _j = 25 °C; <u>Fig. 10</u> | - | 1.4 | 1.65 | V |
| V_{GT} | gate trigger voltage | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C};$ Fig. 11 | - | 0.7 | 1 | V |
| | | $V_D = 400 \text{ V}; I_T = 0.1 \text{ A}; T_j = 150 \text{ °C};$ Fig. 11 | 0.25 | 0.4 | - | V |
| I_D | off-state current | $V_D = 600 \text{ V}; T_j = 25 ^{\circ}\text{C}$ | - | - | 10 | μA |
| | | V _D = 600 V; T _j = 150 °C | - | 0.4 | 2 | mA |
| Dynamic | characteristics | | , | ' | , | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 402 V; T_j = 150 °C; (V_{DM} = 67% of V_{DRM}); exponential waveform; gate open circuit | 200 | - | - | V/µs |
| dI _{com} /dt | rate of change of commutating current | V_D = 400 V; T_j = 150 °C; $I_{T(RMS)}$ = 12 A; dV_{com}/dt = 20 V/µs; (snubberless condition); gate open circuit | 2 | 5 | - | A/ms |
| t _{gt} | gate-controlled turn-on time | $I_{TM} = 16 \text{ A}; V_D = 600 \text{ V}; I_G = 0.1 \text{ mA}; $ $dI_G/dt = 5 \text{ A}/\mu\text{s}$ | - | 2 | - | μs |





- (2) T2+ G-
- (3) T2- G-
- (4) T2- G+

Fig. 7. Normalized gate trigger current as a function of junction temperature

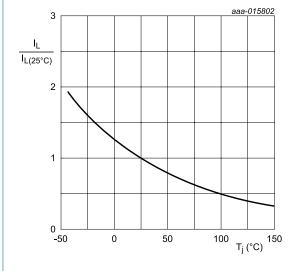


Fig. 8. Normalized latching current as a function of junction temperature

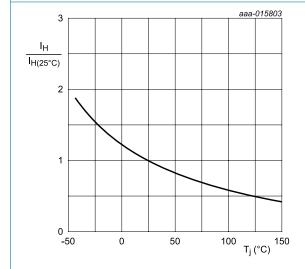
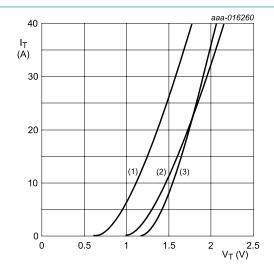


Fig. 9. Normalized holding current as a function of junction temperature



 V_o = 1.108 V; R_s = 0.034 Ω

(1) T_j = 150 °C; typical values (2) T_j = 150 °C; maximum values

(3) T_i = 25 °C; maximum values

Fig. 10. On-state current as a function of on-state voltage

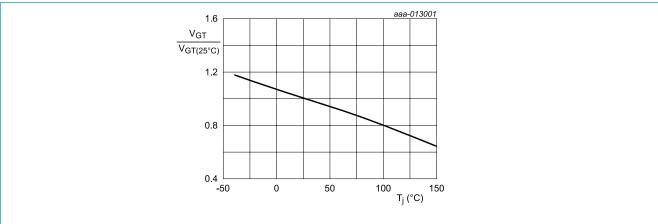


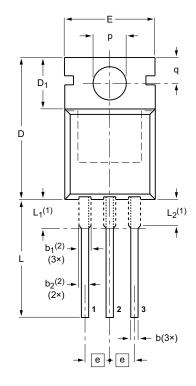
Fig. 11. Normalized gate trigger voltage as a function of junction temperature

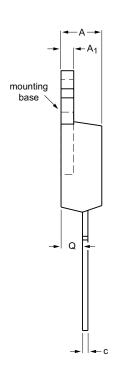
4Q Triad

11. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78





0 5 10 mm

DIMENSIONS (mm are the original dimensions)

| UNIT | А | A ₁ | b | b ₁ ⁽²⁾ | b ₂ ⁽²⁾ | С | D | D ₁ | E | е | L | L ₁ ⁽¹⁾ | L ₂ ⁽¹⁾ max. | р | q | Q |
|------|------------|----------------|------------|-------------------------------|-------------------------------|------------|--------------|----------------|-------------|------|--------------|-------------------------------|---------------------------------------|------------|------------|------------|
| mm | 4.7 4.1 | 1.40 1.25 | 0.9 0.6 | 1.6 1.0 | 1.3 1.0 | 0.7 0.4 | 16.0 15.2 | 6.6 5.9 | 10.3 9.7 | 2.54 | 15.0 12.8 | 3.30 2.79 | 3.0 | 3.8 3.5 | 3.0 2.7 | 2.6 2.2 |

Notes

- Lead shoulder designs may vary.
- 2. Dimension includes excess dambar.

| OUTLINE | DUTLINE REFERENCES | | | EUROPEAN | ISSUE DATE | | |
|---------|--------------------|-----------------|-------------|----------|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | JEDEC JEITA | | PROJECTION | ISSUE DATE | |
| SOT78 | | 3-lead TO-220AB | SC-46 | | | 08-04-23 08-06-13 | |

12. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|--------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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